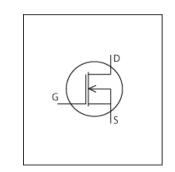


PSpice Model NMOS RENESAS UPA1764



Model Information

Model A macro model based on BSIM3

Call Name MDC_UPA1764_PS

Pin Assign 1:D 2:G 3:S

File List Model Library MDC_UPA1764_PS01.lib

Model Report MDC_UPA1764_PS.pdf (this file)

Verified Simulator Version

Note

PSpice version 16.6

References

The information which was used for modeling is as follow:

[Data Sheet]

Date/Version May-01Product name UPA1764

Company name Renesas Electronics Corporation

 $\begin{tabular}{l} \blacksquare Characteristics & IdVgs[Temp], IdVds[Vgs], Crss, Coss, Ciss, Rds(on)Vgs[Id], Rds \\ \end{tabular}$

(on)Id[Vgs],VthTemp[Id],Rds(on)Temp[Vgs],IsVsd[Vgs],Vds

Qg[Vdd],VgsQg[Vdd]

Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

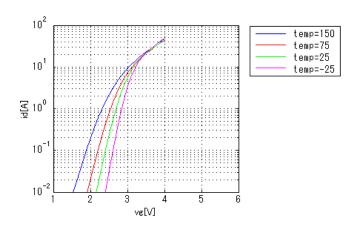
Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	60	V
Gate-source voltage (DC)	0	to	20	V
Temperature	-55	to	150	deg C



Simulation results are following. Explanatory notes — : simulated

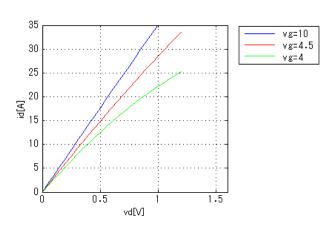
IdVgs[Temp]

Vds = 10V



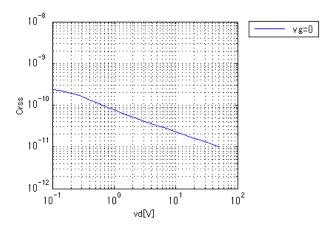
IdVds[Vgs]

Temp. = 25deg C



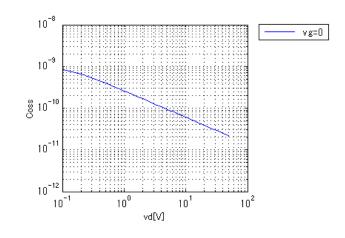
Crss

Freq. = 1MHz



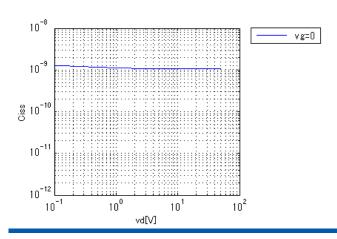
Coss

Freq. = 1MHz

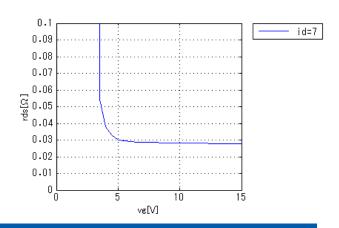


Ciss

Freq. = 1MHz



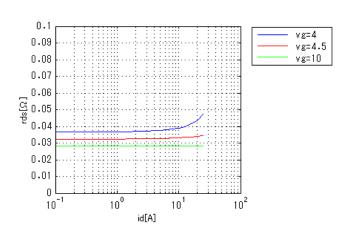
Rds(on)Vgs[ld]





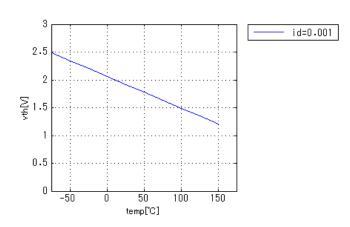
Simulation results are following. Explanatory notes - : simulated

Rds(on)Id[Vgs]



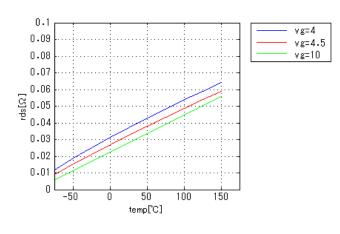
VthTemp[Id]

Vds = 10V

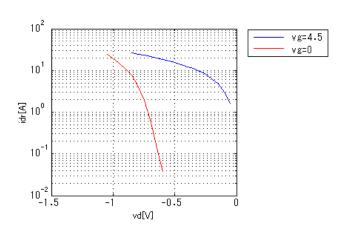


Rds(on)Temp[Vgs]

Id = 3.5A

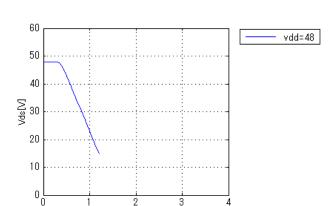


IsVsd[Vgs]



VdsQg[Vdd]

Id = 7A

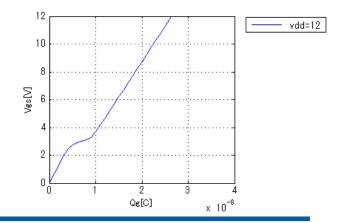


x 10⁻⁸

Qg[C]

VgsQg[Vdd]

Id = 7A





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